

EMarker chip for USB Type-C PD3.2 100W/140W cable

Product Features

- Compliant with PD 3.2: Supports SOP communication, integrated transceiver (BMC PHY), and also supports structured VDM version
- VIN has a wide operating voltage range of 2.9V to 42V
- VIN operates at a minimum of 2.9V and supports direct power supply from VCONN
- After connecting a 1K resistor in series with VIN, it supports up to 50V VBUS
- After connecting a 2K resistor and a 0.1uF capacitor in series with VIN, it supports up to 60V VBUS
- CC withstand voltage up to 36V
- Support FUNC settings to meet different wire requirements
- Package: SOT23-5 (solder pads compatible with FS612A series)

Product Overview

FS612BH is an eMarker with USB Type-C interface. It complies with the USB PD 3.2 protocol.

FS612BH can be directly powered by a 1K resistor connected in series with VBUS, supporting 60V VBUS, and is used in 5-core solutions.

FS612BH can be powered by VCONN and applied to dual core solutions..

Use SOT23-5 minimalist packaging.

FS612BH is suitable for wires with a power of 240W 48V/5A.

Application field

USB Type-C cable

Order information

Part No	Package	Pcs/Reel
FS612BH	SOT23	3000

V1.3(202410)



Chip packaging and pin definition



Pic 1. Pin definition

Table 1. FS612BH Pin function description

FS612BH	Name of the pin	Description
1	VBUS/VCONN	Power supply, can be connected to VBUS or VCONN
2	NC	Mid-air
3	CC	Connect to USB Type-C CC
4	FUNC	External resistor, choose different cable configurations
5	GND	Chip ground

Extreme operating range

Table 2. Maximum operating range

Parameter	Value
	-0.5V~42V
VBUS/VCONN	<55V(Connect 1K resistors in series)
	<65V (Connected in series with 2K resistor)
CC	-0.5V~36V
Storage temperature	-65℃~150℃
Working temperature (connector)	-40℃~125℃
Anti static ability	±2000 V

The maximum operating range listed in the table above, if the limit is exceeded, the chip may be permanently damaged. Users

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should try to avoid it.

Normal operating range

Table 3. Normal operating range

Parameter	Value	
	2.9V~30V	
VDLICA/CONN	<50V (Connect 1K resistors in series)	
VBUS/VCONN	<60V (connected in series with 2K resistor and	
	0.1uF capacitor)	
CC	0~5V	
Power consumption - working status (VBUS=5 V)	<5mW	
Working temperature (connector)	-40℃~125℃	
Environmental temperature	-40°C~85°C	

Function Description

FS612BH is an Emarker chip. Used for low-cost TYPE-C cables. FS612BH supports a wide range of input voltages, so it can be directly powered by VBUS or VCONN. FS612BH supports the latest USB PD 3.2 protocol. The ultra-high CC withstand voltage ensures that the chip will not be damaged.

FS612BH has FUNC selection, allowing for the selection of different wire configurations. Used for 240W 48V/5A applications.

VBUS/VCONN

0.1uF capacitor is optional to improve power supply stability.

It can be connected to TYPEC VBUS through a 1K resistor.

You can connect TYPEC VBUS through a 2K resistor, at which point a 0.1uF capacitor must be connected. Can be directly connected to TYPEC VCONN.

CC

Can support 36V withstand voltage.

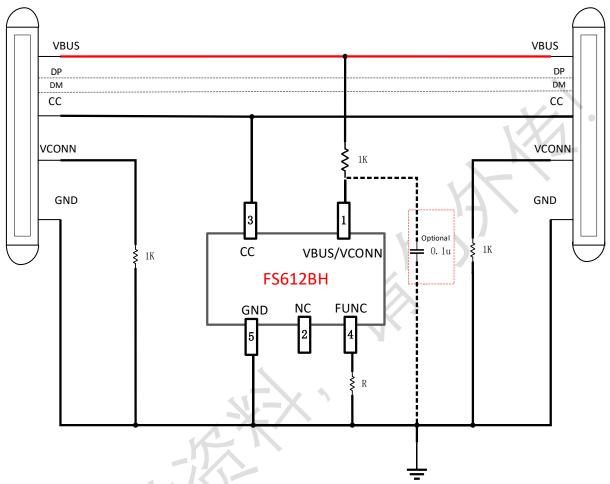
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Application example

5-Core Single Chip Application (FS612BH)



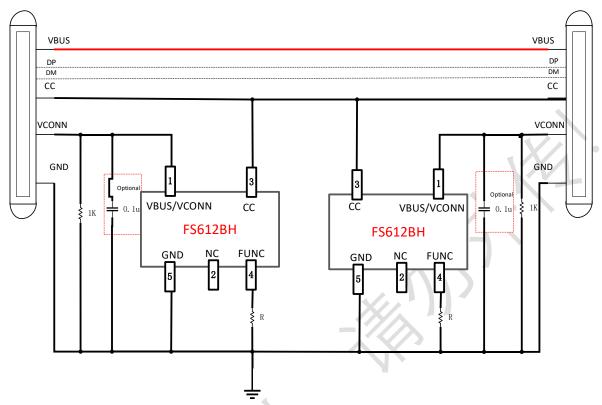
FS612BH Application Diagram (5-Chip Single Chip)

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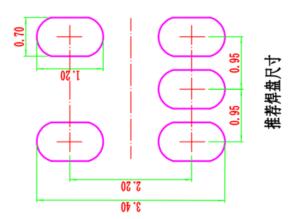
5-core dual chip application (FS612BH)



FS612BH application diagram (5-core dual chip)

Layout suggestion

In order to be compatible with the FS612A series (SOT23) packaging, it is recommended that customers follow the following size layout:

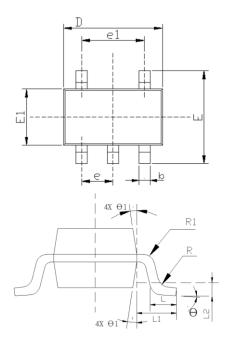


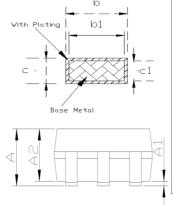
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Package outline drawing

SOT23-5

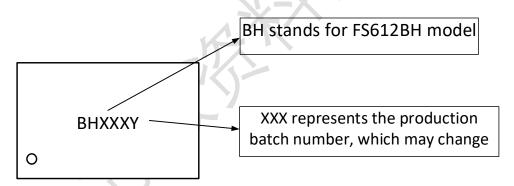




		limensio		
SYMBOL		sure=Millime NDMINAL		
A	-	-	1,35	
A1	0	-	0.15	
A2	1.00	1.10	1.20	
b	0.35	-	0.45	
b1	0.32	-	0.38	
C	0.14	-	0.20	
⊂1	0.14	0.15	0.16	
D	2,82	2,92	3.02	
Ε	2.60	2,80	3.00	
E1	1.526	1.626	1.726	
6	0.90	0.95	1.00	
€1	1.80	1.90	2.00	
L	0,35	0.45	0.60	
L1	0.6 REF			
L2	0.25 REF			
R	0.10	-	-	
R1	0.10	-	0.25	
Θ	0.	4°	8°	
Θ 1	5°	10°	15°	

- All DIMENSIONS REFER TO JEDEC STANDARD MO-178
 DIMENSION D DOES NOT INCLUDE MOLD FLASH
 DIMENSION EL DOES NOT INCLUDE MOLD FLASH
 FLASH OR PROTRUSION SHALL NOT EXCEED 0.25mm PER SIDE.

Chip silk screen information



- 1. FS612BH model information: BH, fixed and unchanged
- 2. The production batch number code is used to distinguish the batch number information each time, based on changes in the production batch

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Company information and statement

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